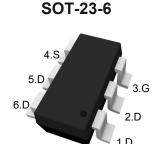
TN04P30SG



Features

- High power and current handing capability
- V_{DS}= -30V,I_D= -4.1A
 R_{DS(on)}< 60mΩ @V_{GS}= -10V

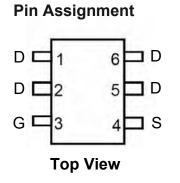


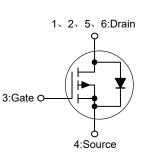
Marking Code:3407

Schematic Diagram

Applications

- PWM applications
- Load switch
- Power management





Absolute Maximum Ratings

Ratings at 25°C ambient temperature unless otherwise specified.

Parameter	Symbol	Value	Unit
Drain-Source Voltage	-V _{DS}	30	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	-I _D	4.1	A
Drain Current-Pulsed Note1	-I _{DM}	20	А
Maximum Power Dissipation	PD	1.2	W
Junction Temperature	TJ	150	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Thermal Characteristics

Thermal Resistance, Junction-to-Ambient Note2	Reja	104	°C/W
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Electrical Characteristics

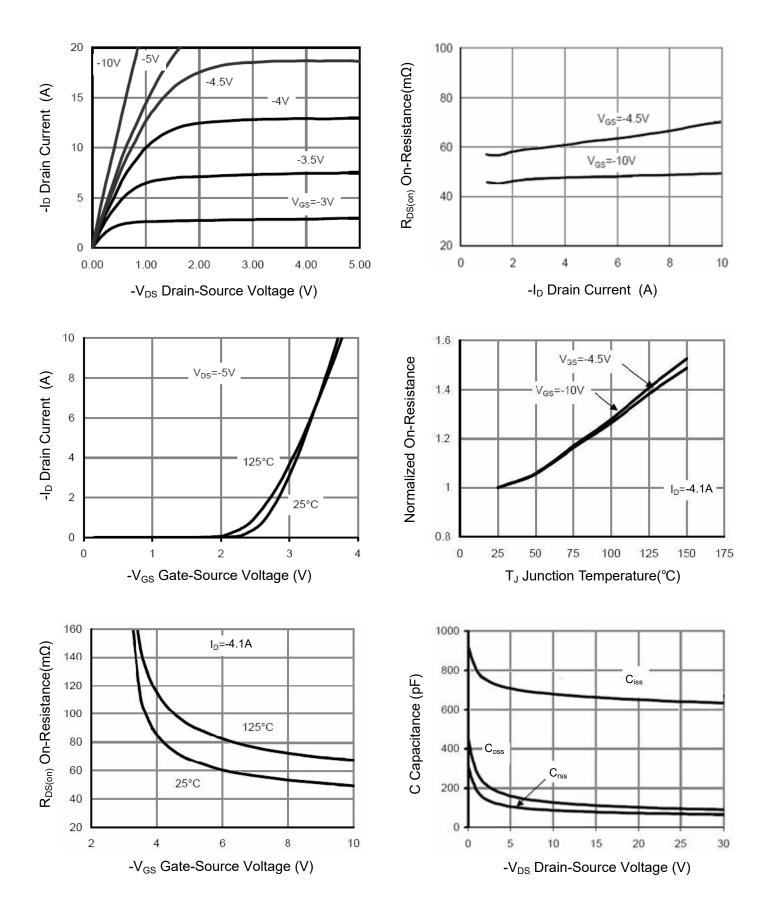
(Ta=25°C unless otherwise specified)

Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	-V _{(BR)DSS}	V _{GS} =0V,I _D =-250µA	30			V
Zero Gate Voltage Drain Current	-I _{DSS}	V _{DS} =-24V,V _{GS} =0V			1	μA
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _{DS} =0V			±100	nA
Gate Threshold Voltage Note3	-V _{GS(th)}	V _{DS} =V _{GS} ,I _D =-250µA	1	1.4	3	V
		V _{GS} =-10V, I _D =-4.1A		50	60	mΩ
Drain-source on-resistance Note2	R _{DS(on)}	V _{GS} =-4.5V, I _D =-3A		68	87	mΩ
Forward Transconductance Note3	g fs	V _{DS} =-5V,I _D =-4A	5.5			S
Dynamic Characteristics			1			
Input Capacitance	Ciss	V _{DS} =-15V,V _{GS} =0V,f=1MHz		650		pF
Output Capacitance	Coss			105		pF
Reverse Transfer Capacitance	C _{rss}			65		pF
Switching Characteristics			1			
Turn-on Delay Time	t _{d(on)}	V _{DD} =-15V,R _L =3.6Ω V _{GS} =-10V,R _{CEN} =3Ω		8.5		nS
Turn-on Rise Time	tr			4.5		nS
Turn-off Delay Time	t _{d(off)}			26		nS
Turn-off Fall Time	t _f			12.5		nS
Total Gate Charge	Qg	V _{DS} =-15V I _D = -4.1A,V _{GS} =-10V		12.5		nC
Gate-Source Charge	Q _{gs}			2.8		nC
Gate-Drain Charge	Q _{gd}			2.7		nC
Source-Drain Diode Characteristic	s					
Diode Forward Voltage Note3	-V _{SD}	V _{GS} =0V,I _S =-4.1A			1.2	V
Diode Forward Current Note2	-ls				4.1	Α

Note: 1. Repetitive Rating: Pulse width limited by maximum junction temperature. 2. Surface Mounted on FR4 Board, t \leq 10 sec.

3. Pulse Test: Pulse width≤300µs, duty cycle≤2%.

Typical Characteristic Curves



P-Channel Enhancement Mode Power MOSFET

12

10

8

6

4

2

0

0

V_{DS}=-15V

I_D= -4.1A

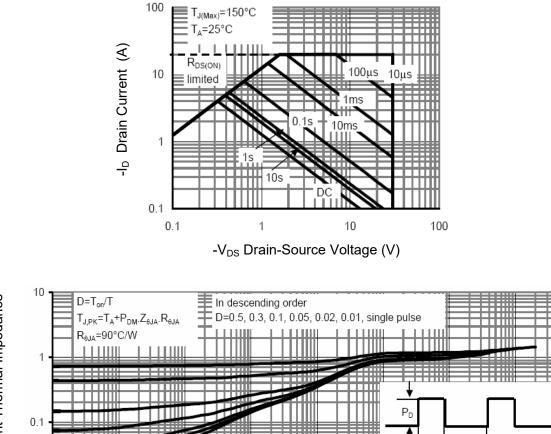
4

8

Q_q Gate Charge (nC)

-V_{GS} Gate-Source Voltage (V)

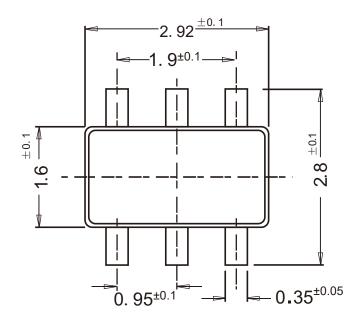
1E+01 -Is Reverse Drain Current (A) 1E+00 1E-01 125°C 1E-02 1E-03 25°C 1E-04 1E-05 1E-06 16 0.0 0.2 0.4 0.6 0.8 1.0 1.2 -V_{DS} Drain-Source Voltage (V)

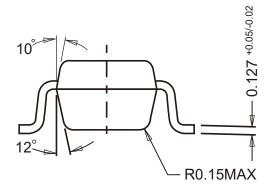


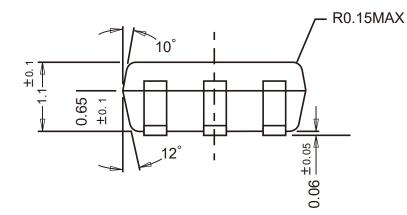
Transient Thermal Impedance r(t),Normalized Effective TTT Single Pulse 0.01 0.00001 0.0001 0.001 0.01 0.1 1 10 100 1000 Square Wave Pluse Duration(sec)

Package Outline

SOT-23-6 Dimensions in mm







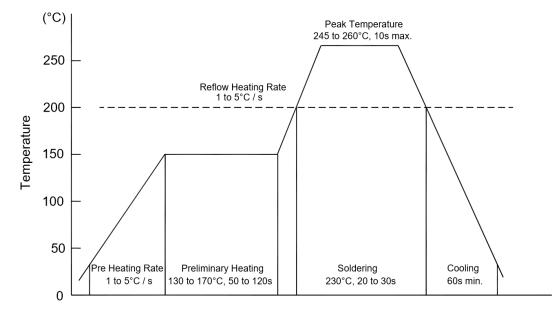
Ordering Information

Device	Package	Shipping
TN04P30SG	TN04P30SG SOT-23-6 3,00	

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Conditions of Soldering and Storage

Recommended condition of reflow soldering



Recommended peak temperature is over 245 °C. If peak temperature is below 245 °C, you may adjust the following parameters:

- Time length of peak temperature (longer)
- Time length of soldering (longer)
- Thickness of solder paste (thicker)

Conditions of hand soldering

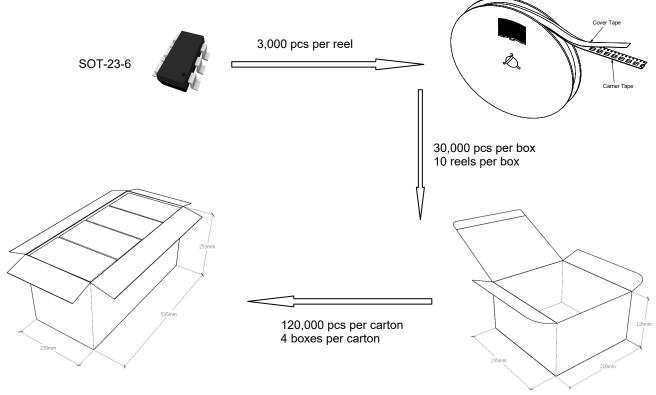
- Temperature: 370 °C
- Time: 3s max.
- Times: one time

• Storage conditions

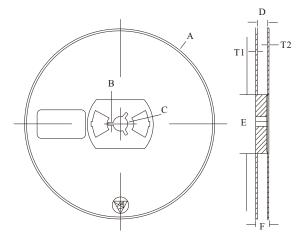
- Temperature 5 to 40 °C
- Humidity
 30 to 80% RH
- Recommended period One year after manufacturing

Package Specifications

The method of packaging ۲

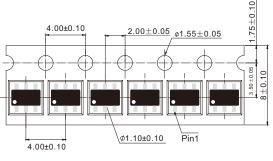


Embossed tape and reel data



Symbol	Value (unit: mm)	
A	Ø 177.8±1	
В	2.7±0.2	
С	Ø 13.5±0.2	
E	Ø 54.5±0.2	
F	12.3±0.3	
D	9.6+2/-0.3	
T1	1.0±0.2	
T2	1.2±0.2	





Tape (8mm)

Contact Information

TANI website: http://www.tanisemi.com Email:tani@tanisemi.com

For additional information, please contact your local Sales Representative.

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Product Specification Statement

The product specification aims to provide users with a reference regarding various product parameters, performance, and usage. It presents certain aspects of the product's performance in graphical form and is intended solely for users to select product and make product comparisons, enabling users to better understand and evaluate the characteristics and advantages of the product. It does not constitute any commitment, warranty, or guarantee.

The product parameters described in the product specification are numerical values, characteristics, and functions obtained through actual testing or theoretical calculations of the product in an independent or ideal state. Due to the complexity of product applications and variations in test conditions and equipment, there may be slight fluctuations in parameter test values. TANI shall not guarantee that the actual performance of the product when installed in the customer's system or equipment will be entirely consistent with the product specification, especially concerning dynamic parameters. It is recommended that users consult with professionals for product selection and system design. Users should also thoroughly validate and assess whether the actual parameters and performance when installed in their respective systems or equipment meet their requirements or expectations. Additionally, users should exercise caution in verifying product compatibility issues, and TANI assumes no responsibility for the application of the product. TANI strives to provide accurate and up -to- date information to the best of our ability. However, due to technical, human, or other reasons, TANI guarantee that the information provided in the product specifications.

TANI reserves the right to revise or update the product specification and the products at any time without prior notice, and the user's continued use of the product specification is considered an acceptance of these revisions and updates. Prior to purchasing and using the product, users should verify the above information with TANI to ensure that the prod uct specification is the most current, effective, and complete. If users are particularly concerned about product parameters, please consult TANI in detail or request relevant product test reports. Any data not explicitly mentioned in the product specification shall be subject to separate agreement.

Users are advised to pay attention to the parameter limit values specified in the product specification and maintain a certain margin in design or application to ensure that the product does not exceed the parameter limit values defined in the product specification. This precaution should be taken to avoid exceeding one or more of the limit values, which may result in permanent irreversible damage to the product, ultimately affecting the quality and reliability of the system or equipment.

The design of the product is intended to meet civilian needs and is not guaranteed for use in harsh environments or precision equipment. It is not recommended for use in systems or equipment such as medical devices, aircraft, nuclear power, and similar systems, where failures in these systems or equipment could reasonably be expected to result in personal injury. TANI shall assume no responsibility for any consequences resulting from such usage.

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